



# MX23C6410

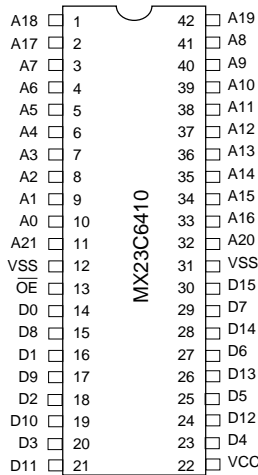
## 64M-BIT Mask ROM (8/16 Bit Output)

### FEATURES

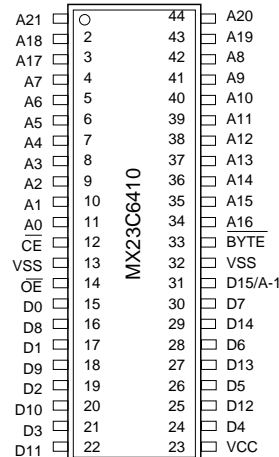
- Bit organization
  - 8M x 8 (byte mode not for PDIP)
  - 4M x 16 (word mode)
- Fast access time
  - Random access: 100ns (max.)
- Current
  - Operating: 100mA (max.)
  - Standby: 100uA (max.)
- Supply voltage
  - 5V±10%
- Package
  - 44 pin SOP (500 mil)
  - 48 pin TSOP (20mm x 12mm)
  - 42 pin PDIP (600mil)

### PIN CONFIGURATION

#### 42 PDIP (Word mode only & without CE pin)



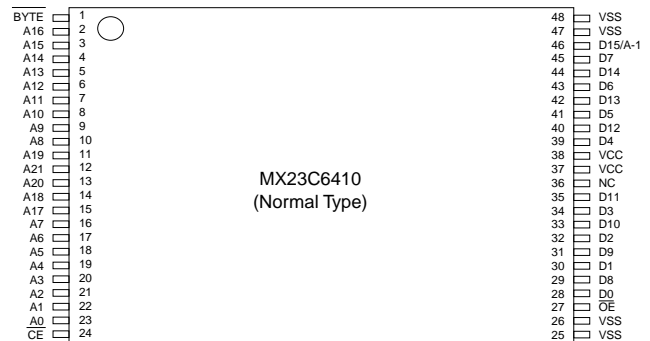
#### 44 SOP



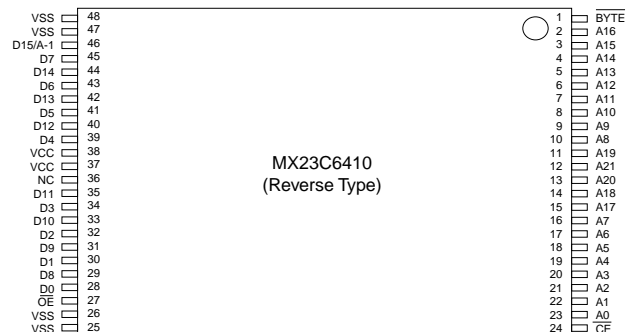
### ORDER INFORMATION

Part No.	Access Time	Package
MX23C6410MC-10	100ns	44 pin SOP
MX23C6410MC-12	120ns	44 pin SOP
MX23C6410MC-15	150ns	44 pin SOP
MX23C6410TC-10	100ns	48 pin TSOP
MX23C6410TC-12	120ns	48 pin TSOP
MX23C6410TC-15	150ns	48 pin TSOP
MX23C6410RC-10	100ns	48 pin TSOP (Reverse type)
MX23C6410RC-12	120ns	48 pin TSOP (Reverse type)
MX23C6410RC-15	150ns	48 pin TSOP (Reverse type)
MX23C6410PC-10	100ns	42 pin PDIP
MX23C6410PC-12	120ns	42 pin PDIP
MX23C6410PC-15	150ns	42 pin PDIP

#### 48 TSOP (NORMAL TYPE)



#### 48 TSOP (REVERSE TYPE)



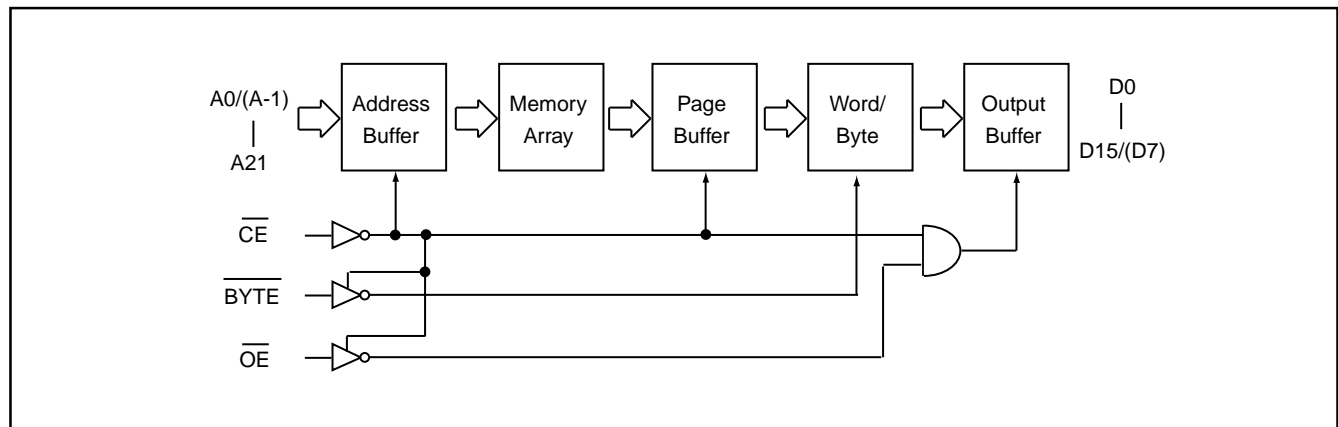
## PIN DESCRIPTION

Symbol	Pin Function
A0~A21	Address Inputs
D0~D14	Data Outputs
D15/A-1	D15 (Word Mode) / LSB Address (Byte Mode)
$\overline{CE}$	Chip Enable Input
$\overline{OE}$	Output Enable Input
Byte	Word / Byte Mode Selection
VCC	Power Supply Pin
VSS	Ground Pin
NC	No Connection

## MODE SELECTION

$\overline{CE}$	$\overline{OE}$	Byte	D15/A-1	D0~D7	D8~D15	Mode	Power
H	X	X	X	High Z	High Z	-	Stand-by
L	H	X	X	High Z	High Z	-	Active
L	L	H	Output	D0~D7	D8~D15	Word	Active
L	L	L	Input	D0~D7	High Z	Byte	Active

## BLOCK DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Ratings
Voltage on any Pin Relative to VSS	VIN	-0.8V to VCC+2.0V (Note)
Ambient Operating Temperature	T <sub>opr</sub>	0°C to 70°C
Storage Temperature	T <sub>stg</sub>	-65°C to 125°C

Note: Minimum DC voltage on input or I/O pins is -0.5V. During voltage transitions, inputs may undershoot VSS to -0.8V for periods of up to 20ns. Maximum DC voltage on input or I/O pins is VCC+0.5V. During voltage transitions, input may overshoot VCC to VCC+2.0V for periods of up to 20ns.

## DC CHARACTERISTICS (Ta = 0°C ~ 70°C, VCC = 5V±10%)

Item	Symbol	MIN.	MAX.	Conditions
Output High Voltage	VOH	2.4V	-	IOH = -1.0mA
Output Low Voltage	VOL	-	0.4V	IOL = 2.1mA
Input High Voltage	VIH	2.2V	VCC+0.3V	
Input Low Voltage	VIL	-0.3V	0.8V	
Input Leakage Current	ILI	-	5uA	0V, VCC
Output Leakage Current	ILO	-	5uA	0V, VCC
Operating Current	ICC1	-	100mA	tRC = 120ns, all output open
Standby Current (TTL)	ISTB1	-	1mA	CE = VIH
Standby Current (cmos)	ISTB2	-	100uA	CE > VCC-0.2V
Input Capacitance	CIN	-	10pF	Ta = 25°C, f = 1MHZ
Output Capacitance	COUT	-	10pF	Ta = 25°C, f = 1MHZ

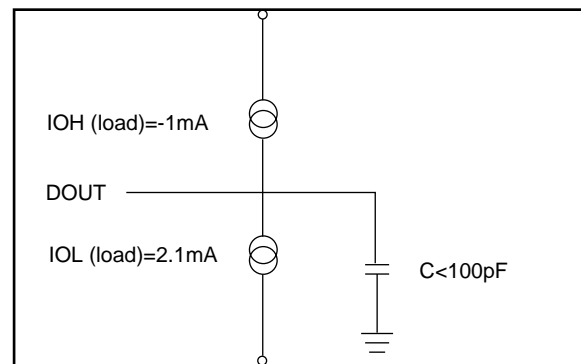
## AC CHARACTERISTICS (Ta = 0°C ~ 70°C, VCC = 5V±10%)

Item	Symbol	23C6410-10		23C6410-12		23C6410-15	
		MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
Read Cycle Time	tRC	100ns	-	120ns	-	150ns	-
Address Access Time	tAA	-	100ns	-	120ns	-	150ns
Chip Enable Access Time	tACE	-	100ns	-	120ns	-	150ns
Output Enable Time	tOE	-	50ns	-	60ns	-	70ns
Output Hold After Address	tOH	0ns	-	0ns	-	0ns	-
Output High Z Delay	tHZ	-	20ns	-	20ns	-	20ns

Note: Output high-impedance delay (tHZ) is measured from OE or CE going high, and this parameter guaranteed by design over the full voltage and temperature operating range - not tested.

## AC Test Conditions

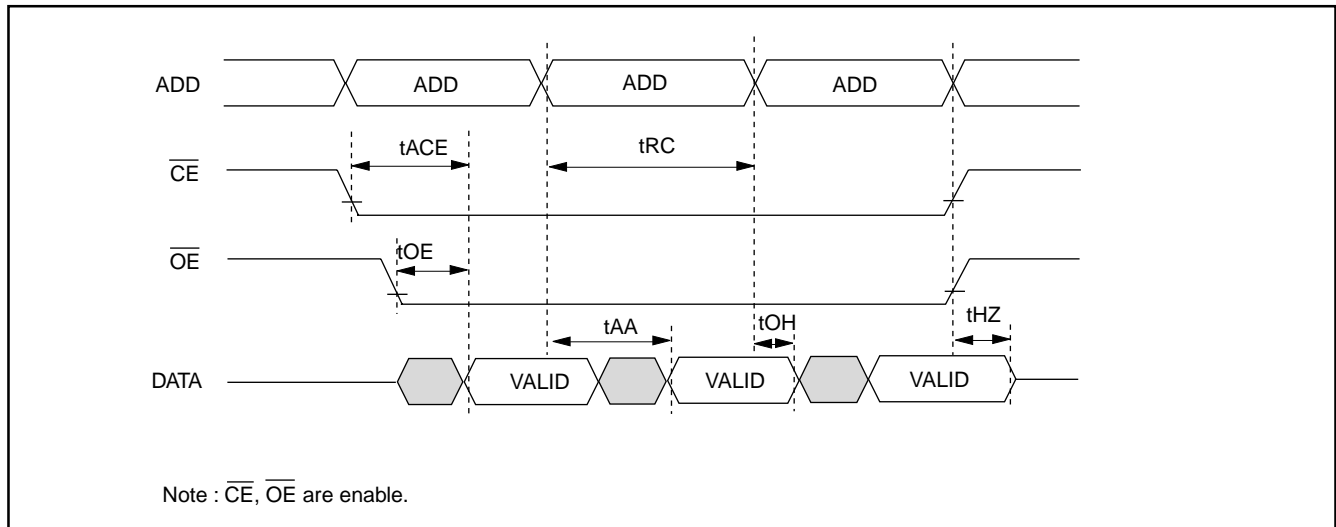
Input Pulse Levels	0.4V~ 2.4V
Input Rise and Fall Times	10ns
Input Timing Level	1.4V
Output Timing Level	0.8V and 2.0V
Output Load	See Figure



Note: No output loading is present in tester load board.

Active loading is used and under software programming control.

Output loading capacitance includes load board's and all stray capacitance.

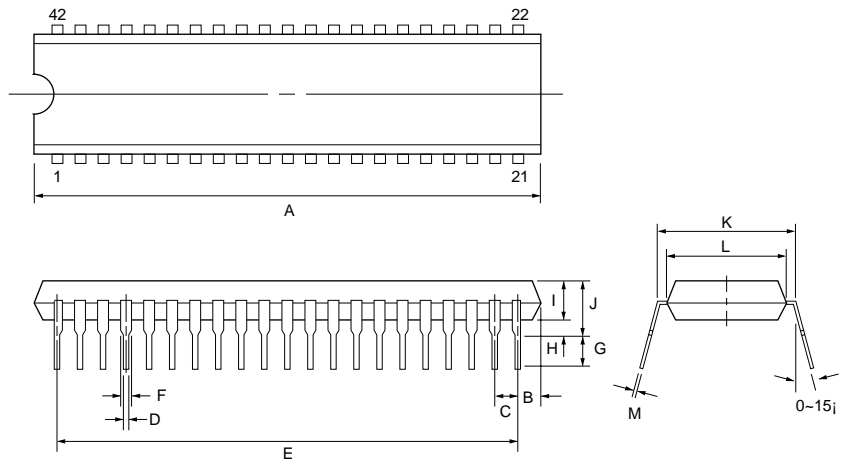
**TIMING DIAGRAM****RANDOM READ**

## PACKAGE INFORMATION

### 42-PIN PLASTIC DIP(600 mil)

ITEM	MILLIMETERS	INCHES
A	52.54 max.	2.070 max.
B	0.76 [REF]	.030 [REF]
C	2.54 [TP]	.100 [TP]
D	.46 [Typ.]	.018 [Typ.]
E	50.76	2.000
F	1.27 [Typ.]	.050 [Typ.]
G	3.30 ± .25	.130 ± .010
H	.51 [REF]	.020 [REF]
I	3.94 ± .25	.155 ± .010
J	5.33 max.	.210 max.
K	15.22 ± .25	.600 ± .010
L	13.97 ± .25	.550 ± .010
M	.25 [Typ.]	.010 [Typ.]

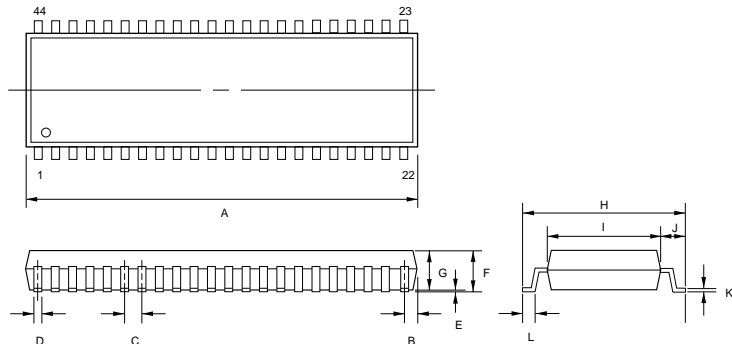
**NOTE:** Each lead centerline is located within .25 mm [.01 inch] of its true position [TP] at maximum material condition.



### 44-PIN PLASTIC SOP

ITEM	MILLIMETERS	INCHES
A	28.70 max.	1.130 max.
B	1.10 [REF]	.043 [REF]
C	1.27 [TP]	.050 [TP]
D	.40 ± .10 [Typ.]	.016 ± .004 [Typ.]
E	.010 min.	.004 min.
F	3.00 max.	.118 max.
G	2.80 ± .13	.110 ± .005
H	16.04 ± .30	.631 ± .012
I	12.60	.496
J	1.72	.068
K	.15 ± .10 [Typ.]	.006 ± .004 [Typ.]
L	.80 ± .20	.031 ± .008

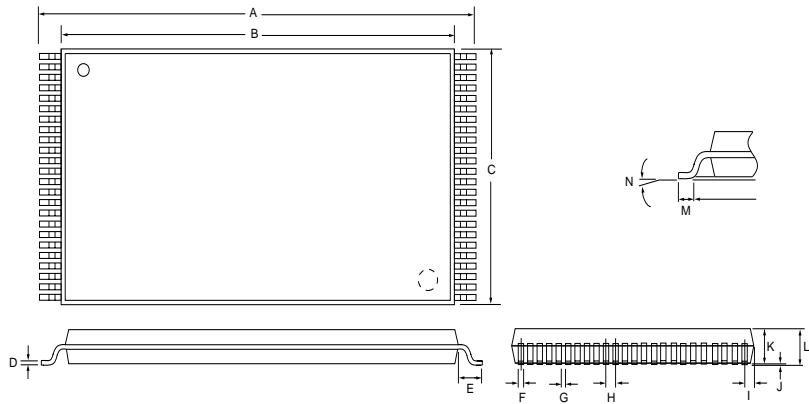
**NOTE:** Each lead centerline is located within .25 mm [.01 inch] of its true position [TP] at maximum material condition.



## 48-PIN PLASTIC TSOP

ITEM	MILLIMETERS	INCHES
A	20.0 ± .20	.787 ± .008
B	18.40 ± .10	.724 ± .004
C	12.20 max.	.480 max.
D	0.15 [Typ.]	.006 [Typ.]
E	.80 [Typ.]	.031 [Typ.]
F	.20 ± .10	.008 ± .004
G	.30 ± .10	.012 ± .004
H	.50 [Typ.]	.020 [Typ.]
I	.45 max.	.018 max.
J	0 ~ .20	0 ~ .008
K	1.00 ± .10	.039 ± .004
L	1.27 max.	.050 max.
M	.50	.020
N	0 ~ 5°	.500

**NOTE:** Each lead centerline is located within .25 mm [.01 inch] of its true position [TP] at maximum material condition.





**REVISION HISTORY**

Revision	Description	Page	Date
2.1	AC Characteristics: tOH 10ns --> 0ns	P3	FEB/01/1999



**MX23C6410**

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